RICOH

R1202x Series

STEP-UP DC/DC CONVERTER with SHUTDOWN FUNCTION

NO.EA-255-210322

OUTLINE

The R1202x Series are CMOS-based PWM step-up DC/DC converter ICs with low supply current.

Each of these ICs consists of an NMOS FET, NPN transistor, an oscillator, a PWM comparator, a voltage reference unit, an error amplifier, a current limit circuit, an under voltage lockout circuit (UVLO), an over-voltage protection circuit (OVP), a soft-start circuit, a Maxduty limit circuit, and a thermal shutdown protection circuit. By simply using an inductor, a resistor, and capacitors as external components, a high-efficiency step-up DC/DC converter can be easily configured. At the standby mode, a rectifier transistor can separate the output from the input.

The R1202x Series include a thermal shut-down circuit and an under-voltage lockout circuit (UVLO) which separate the output from the input to shut down the current when the overheat caused when the output is connected to the Gnd is detected and also during the UVLO detection. As other protection functions, the R1202x Series contain a cycle by cycle current limit circuit that limits the Lx peak current, and an over-voltage protection circuit (OVP) that detects the output overvoltage.

The R1202x Series offer three versions: the R1202xxxxA/B versions, which are optimized for constant-voltage power supply and the R1202xxxxD version, which is optimized to drive serial white LEDs with constant current. While the R1202xxxxA version discharges the VouT output to 0V at the shutdown, the R1202xxxxB version doesn't. The brightness of the white LEDs can be adjusted quickly by applying a PWM signal (200Hz to 300kHz) to the CE pin.

The R1202x Series are available in DFN1616-6B and TSOT-23-6 packages.

FEATURES

Input Voltage Range	2.3V to 5.5V (R1202xxxxA/B) 1.8V to 5.5V (R1202xxxxD)
Supply Current	,
Standby Current	Max. 5μA
Feedback Voltage	1.0V±15mV (R1202xxxxA/B)
•	0.2V±10mV (R1202xxxxD)
Oscillator Frequency	
Maximum Duty Cycle	
UVLO Function	
	Typ.1.6V (Hys.Typ.0.1V) (R1202xxxxD)
Lx Current Limit Function	
Over Voltage Protection	Select from 14V-23V (Refer the Selection Guide)
•	by external PWM signal (Frequency 200Hz to 300kHz)
Thermal Protection Function	, , , , , , , , , , , , , , , , , , , ,
Built-in Auto Discharge Function	, , , , , , , , , , , , , , , , , , ,
NMOS ON Resistance	
Packages	DFN1616-6B, TSOT-23-6

APPLICATION

- Constant Voltage Power Source for portable equipment
- · OLED power supply for portable equipment
- White LED Backlight for portable equipment

SELECTION GUIDE

The OVP threshold voltage, current limit, package and VFB/Auto discharge are user-selectable options.

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
R1202Lyz1*-TR	DFN1616-6B	5,000 pcs	Yes	Yes
R1202Nyz3*-TR-FE	TSOT-23-6	3,000 pcs	Yes	Yes

y : Designation of OVP threshold

(3) 14V : R1202xxxxA/B/D
(4) 17V : R1202xxxxA/B
(5) 19V : R1202xxxxA/B
(6) 21V : R1202xxxxA/B
(7) 23V : R1202xxxxA/B/D

z : Designation of current limit

(1) 350mA

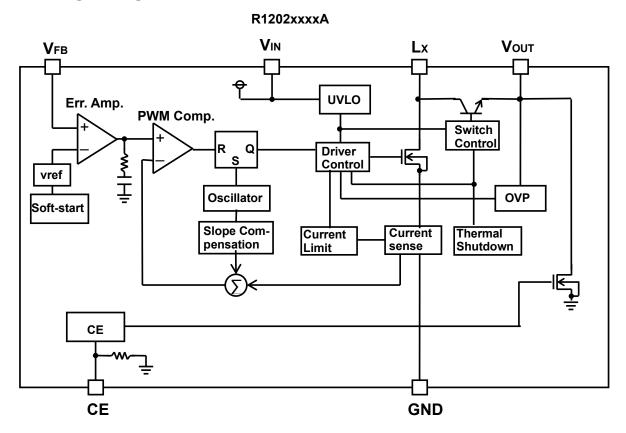
(2) 700mA

* : Designation of VFB, auto discharge function

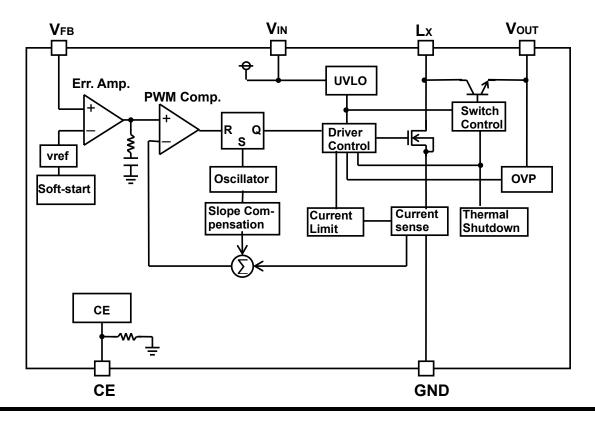
	VFB	Auto discharge
Α	1.0V	0
В	1.0V	×
D	0.2V	×

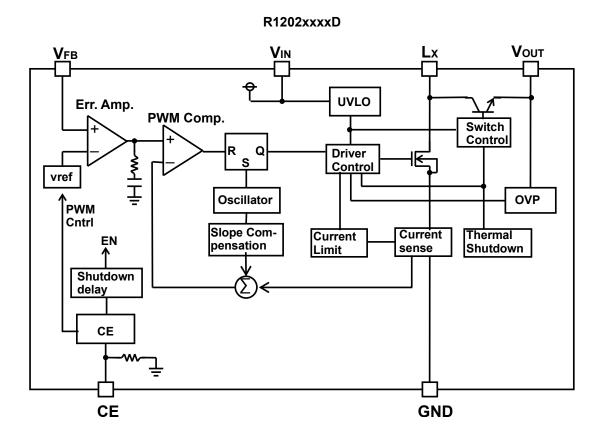
Auto-discharge function quickly lowers the output voltage to 0V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.

BLOCK DIAGRAMS



R1202xxxxB



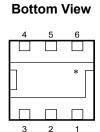


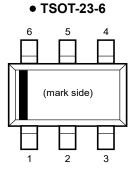
PIN DESCRIPTIONS

• DFN1616-6B

6 5 4

Top View





DFN1616-6B

Pin No	Symbol	Pin Description
1	CE	Chip Enable Pin ("H" Active)
2	V _{FB}	Feedback Pin
3	Lx	Switching Pin (Open Drain Output)
4	GND	Ground Pin
5	Vin	Input Pin
6	Vouт	Output Pin

^{*)} The tab is substrate level (GND). The tab is better to be connected to the GND, but leaving it open is also acceptable.

TSOT-23-6

Pin No	Symbol	Pin Description	
1	CE	Chip Enable Pin ("H" Active)	
2	Vоит	Output Pin	
3	Vin	Input Pin	
4	Lx	Switching Pin (Open Drain Output)	
5	GND	Ground Pin	
6	V _{FB}	Feedback Pin	

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ABSOLUTE MAXIMUM RATINGS

(GND=0V)

Symbol		Item	Rating	Unit
Vin	V _{IN} Pin Voltage		-0.3 to 6.5	V
VCE	CE Pin Voltage		-0.3 to 6.5	V
V _{FB}	V _{FB} Pin Voltage		-0.3 to 6.5	V
Vout	Vоит Pin Voltage	Vout Pin Voltage		
VLX	Lx Pin Voltage	-0.3 to 25	V	
ILX	Lx Pin Current		1000	mA
P _D	Power Dissipation *	DFN1616-6B Power Dissipation * (JEDEC STD. 51-7 Test Land Pattern)		mW
	TSOT-23-6 (Standard Test Land Pattern)		460	
Tj	Junction Temperature Range		-40 to 125	°C
Tstg	Storage Temperature	Storage Temperature Range		°C

^{*)} Refer to POWER DISSIPATION for detailed information.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS

Symbol	Item		Unit	
V	Operating Input Voltage	R1202xxxxA/B	2.3 V to 5.5 V	V
Vin	Operating Input Voltage	R1202xxxxD	1.8 V to 5.5 V	V
Та	Operating Temperature Range		°C	

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

R1202x (Ta=25°C)

Symbol	Item	Cond	itions	Min.	Тур.	Max.	Unit
l _{DD}	Supply Current	V _{IN} =5.5V , V _{FB} =0	V , Lx at no load		0.8	1.2	mA
Istandby	Standby Current	VIN=5.5V , VCE=0	V		1.0	5.0	μА
	UVLO Detect) / f=11:	R1202xxxxA/B	1.9	2.0	2.1	V
V _{UVLO1}	Threshold Voltage	V _{IN} falling	R1202xxxxD	1.5	1.6	1.7	V
V	LIVI O Delegge Veltage	V. riging	R1202xxxxA/B		Vuvlo1 +0.2	2.3	V
Vuvlo2	UVLO Release Voltage	V _{IN} rising	R1202xxxxD		Vuvlo1 +0.1	1.8	V
VCEH	CE Input Voltage "H"	V _{IN} =5.5V		1.5			V
VCEL	CE Input Voltage "L"					0.5	V
Rce	CE Pull Down Resistance				1200		kΩ
V _{FB}	V Voltage Assuragy	Vc=3.6V	R1202xxxxA/B	0.985	1.000	1.015	V
V FB	V _{FB} Voltage Accuracy	VCE-3.6V	R1202xxxxD	0.19	0.2	0.21	
ΔV _{FB} /ΔTa	V _{FB} Voltage Temperature Coefficient	V _{CE} =3.6V, -40°C	≦Ta ≦85°C		±150		ppm/ °C
lғв	V _{FB} Input Current	V _{IN} =5.5V, V _{FB} =0	√ or 5.5V	-0.1		0.1	μА
tstart	Soft-start Time	*R1202xxxxA/B			2.0		ms
Ron	Driver ON Resistance	Vc=3.6V, ILX=10	00mA		1.35		Ω
loff	Driver Leakage Current	V _L x=22V				3.0	μА
1	Driver Current Limit	V 2 CV	R1202xx1xx	250	350	450	
Інм	Driver Current Limit	V _{IN} =3.6V	R1202xx2xx	500	700	900	mA
VF	NPN Forward Voltage	I _L x=100mA			0.8		V
Iswoff1	NPN Leakage Current 1	Vout=22V, VLX=0V				10	μΑ
Iswoff2	NPN Leakage Current 2	Vout=0V, VLx=5.5V				3	μΑ
fosc	Oscillator Frequency	VIN=3.6V, VFB=0\	/	1000	1200	1400	kHz

R1202x NO.EA-255-210322

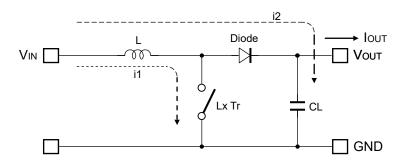
(Ta=25°C)

Symbol	Item	Cond	itions	Min.	Тур.	Max.	Unit
Maxduty	Maximum Duty Cycle	V _{IN} =3.6V, V _{FB} =0V		86	91		%
			R1202x3xxA/B/D	13.2	14	14.8	
		.,	R1202x4xxA/B	16.2	17	17.8	
V_{OVP1}	OVP Detect Voltage	V _{IN} =3.6V, V _{OUT} rising	R1202x5xxA/B	18.2	19	19.8	V
		Voornong	R1202x6xxA/B	20.2	21	21.8	
			R1202x7xxA/B/D	22.2	23	23.8	
			R1202x3xxA/B/D		V _{OVP1} -1.1		
			R1202x4xxA/B		V _{OVP1} -1.3		
V_{OVP2}	OVP Release Voltage	V _{IN} =3.6V, V _{OUT} falling	R1202x5xxA/B		V _{OVP1} -1.4		V
			R1202x6xxA/B		V _{OVP1} -1.5		
			R1202x7xxA/B/D		V _{OVP1} -1.7		
T _{TSD}	Thermal Shutdown Detect Temperature	V _{IN} =3.6V			150		°C
TTSR	Thermal Shutdown Release Temperature	V _{IN} =3.6V			100		°C

THEORY OF OPERATION

Operation of Step-Up DC/DC Converter and Output Current

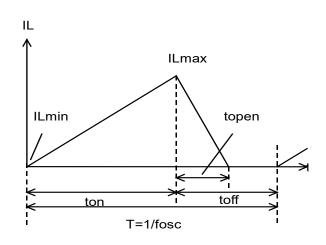
<Basic Circuit>

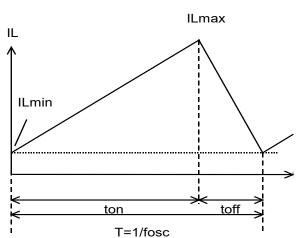


<Current through L>

Discontinuous mode

Continuous mode





There are two operation modes of the step-up PWM control-DC/DC converter. That is the continuous mode and discontinuous mode by the continuousness inductor.

When the transistor turns ON, the voltage of inductor L becomes equal to V_{IN} voltage. The increase value of inductor current (i1) will be

$$\Delta i1 = V_{IN} \times ton / L$$
 Formula 1

As the step-up circuit, during the OFF time (when the transistor turns OFF) the voltage is continually supply from the power supply. The decrease value of inductor current (i2) will be

$$\Delta i2 = (V_{OUT} - V_{IN}) \times t_{Open} / L$$
 Formula 2

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At the PWM control-method, the inductor current become continuously when topen=toff, the DC/DC converter operate as the continuous mode.

In the continuous mode, the variation of current of i1 and i2 is same at regular condition.

$$V_{IN} \times ton / L = (V_{OUT} - V_{IN}) \times toff / L$$
 Formula 3

The duty at continuous mode will be

The average of inductor current at tf = toff will be

$$IL(Ave.) = V_{IN} \times ton / (2 \times L)$$
 Formula 5

If the input voltage = output voltage, the lout will be

$$I_{OUT} = V_{IN}^2 \times ton / (2 \times L \times V_{OUT})$$
 Formula 6

If the lout value is large than above the calculated value (Formula 6), it will become the continuous mode, at this status, the peak current (ILmax) of inductor will be

$$IL_{max} = I_{OUT} \times V_{OUT} / V_{IN} + V_{IN} \times ton / (2 \times L)$$

$$IL_{max} = I_{OUT} \times V_{OUT} / V_{IN} + V_{IN} \times T \times (V_{OUT} - V_{IN}) / (2 \times L \times V_{OUT})$$
Formula 8

The peak current value is larger than the lout value. In case of this, selecting the condition of the input and the output and the external components by considering of ILmax value.

The explanation above is based on the ideal calculation, and the loss caused by Lx switch and the external components are not included.

The actual maximum output current will be between 50% and 80% by the above calculations. Especially, when the IL is large or V_{IN} is low, the loss of V_{IN} is generated with on resistance of the switch. Moreover, it is necessary to consider Vf of the diode (approximately 0.8V) about V_{OUT} .

Soft-Start

R1202xxxxA/B

After inputting "H" to the CE pin, the error amplifier in the DC/DC converter starts from 0V and slowly rises with a time (typ. 2ms) until the set output voltage is reached.

However, immediately after startup, (the input voltage (V_{IN}) – NPN Forward voltage) is output without the soft start control.

R1202xxxxD

By gradually increasing the duty of the PWM signal input to the CE pin, the LED current (luminance) can be slowly increased in the same way as the soft start operation.

Protect Function

If the over current is detected, internal mosfet will turn-off soon. At the next operating period, mosfet will turn-on again and continue to watch the current.

The UVLO function and the thermal shutdown function are turned off the NMOS-driver and NPN-transister when the V_{IN} decreases more than the UVLO detect threshold voltage or the inside of IC exceeds the thermal shutdown detect temperature, and reset IC when the V_{IN} rises more than the UVLO release voltage or the inside of IC falls below the thermal shutdown release temperature, and restart the operation.

Shutdown

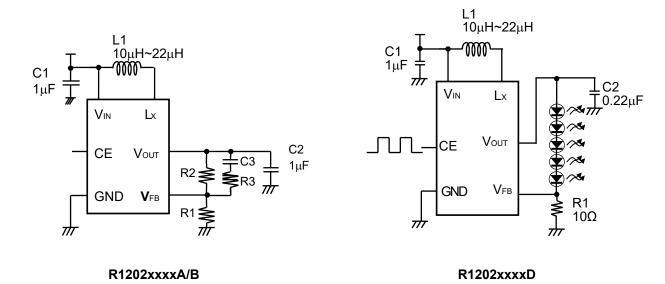
At standby mode, the output is completely separated from the input and shutdown by the NPN transistor of internal IC. However, the leakage current is generated when the Lx pin voltage is higher than V_{IN} pin voltage at standby mode.

R1202xxxxA (with auto discharge function): In the term of standby mode, the switch between Vout to GND is turned ON and output capacitor is discharged.



APPLICATION INFORMATION

Typical Applications



Selection of Inductor

The peak current of the inductor at normal mode can be estimated as the next formula when the efficiency is 80%.

$$ILmax = 1.25 \times Iout \times Vout / Vin + 0.5 \times Vin \times (Vout - Vin) / (L \times Vout \times fosc)$$

In the case of start-up or dimming control by CE pin, inductor transient current flows, and the peak current of it must be equal or less than the current limit of the IC. The peak current should not beyond the rated current of the inductor. The recommended inductance value is $10\mu H$ - $22\mu H$.

Table 1 Peak current value in each condition

Condition				
Vin (V)	Vout (V)	louт (mA)	L (μH)	ILmax (mA)
3	14	20	10	215
3	14	20	22	160
3	21	20	10	280
3	21	20	22	225

Table 2 Recommended inductors

L (μH)	Part No.	Rated current (mA)	Size (mm)
10	LQH32CN100K53	450	3.2x2.5x1.55
10	LQH2MC100K02	225	2.0x1.6x0.9
10	VLF3010A-100	490	2.8x2.6x0.9
10	VLS252010-100	520	2.5x2.0x1.0
10	VLF403212MT-100M	900	4.0×3.2×1.2
22	LQH32CN220K53	250	3.2x2.5x1.55
22	LQH2MC220K02	185	2.0x1.6x0.9
22	VLF3010A-220	330	2.8x2.6x0.9
22	VLF504015MT-220M	930	5.0×4.0×1.5

Selection of Capacitor

Set 1μF or more value bypass capacitor C1 between V_{IN} pin and GND pin as close as possible.

R1202xxxxA/R1202xxxxB

Set $1\mu F - 4.7\mu F$ or more capacitor C2 between VouT and GND pin.

Table 3-A Recommended components for R1202xxxxA/R1202xxxxB

	Rated voltage(V)	Part No.
C1	6.3	CM105B105K06
C2	25	GRM21BR11E105K
C3	25	22pF
R1		For Vout Setting
R2		For Vou⊤ Setting
R3		2kΩ

If the transient drop of output voltage by the load fluctuation is large and exceeds the allowable range in above setting, refer to Table 3-B to change the capacitors of C2 and C3 for the response improvement and the transient voltage drop reduction.

Table 3-B Recommended components for R1202xxxxA/R1202xxxxB

	Rated voltage(V)	Part No.
C1	6.3	CM105B105K06
C2	50	GRM31CR71H475M
C3	25	220pF
R1		For Vout Setting
R2		For Vou⊤ Setting
R3		2kΩ

R1202xxxxD

Set 0.22µF or more capacitor C2 between Vout and GND pin.

The rated voltage of C2 should be 25V or more.

Table 4 Recommended components for R1202xxxxD

	Rated voltage(V)	Part No.
C1	6.3	CM105B105K06
C2	25	GRM21BR11E224

External Components Setting

If the spike noise of V_{OUT} may be large for R1202xxxxA/B, the spike noise may be picked into V_{FB} pin and make the operation unstable. In this case, use a R3 of the resistance value in the range from $1k\Omega$ to $5k\Omega$ to reduce a noise level of V_{FB} .

● The Method of Output Voltage Setting (R1202xxxxA/B)

The output voltage (Vout) can be calculated with divider resistors (R1 and R2) values as the following formula:

The total value of R1 and R2 should be equal or less than $300k\Omega$. Make the V_{IN} and GND line sufficient. The large current flows through the V_{IN} and GND line due to the switching. If this impedance (V_{IN} and GND line) is high, the internal voltage of the IC may shift by the switching current, and the operating may become unstable. Moreover, when the built-in Lx switch is turn OFF, the spike noise caused by the inductor may be generated. As a result of this, recommendation voltage rating of capacitor (C2) value is equal 1.5 times larger or more than the setting output voltage.

LED Current setting (R1202xxxxD)

When CE pin input is "H" (Duty=100%), LED current can be set with feedback resistor (R1)

LED Dimming Control (R1202xxxxD)

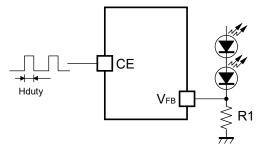
The LED brightness can be controlled by inputting the PWM signal to the CE pin. If the CE pin input is "L" in the fixed time (Typ.0.5ms), the IC becomes the standby mode and turns OFF LEDs.

The current of LEDs can be controlled by Duty of the PWM signal of the input CE pin. The current of LEDs when High-Duty of the CE input is "Hduty" reaches the value as calculatable following formula.

$$I_{LED} = Hduty \times V_{FB} / R1$$

The frequency of the PWM signal is using the range between 200Hz to 300kHz.

When controlling the LED brightness by the PWM signal of 20kHz or less, the increasing or decreasing of the inductor current might be make a sounds in the hearable sound wave area. In that case, please use the PWM signal in the high frequency area.



Dimming control by CE pin input

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● I_{LED} accuracy (R1202xxxxD)

LED current (I_{LED}) is affected by the offset voltage of the error amplifier in the DC/DC converter.

LED might turn off due to the offset voltage variation, when brightness is controlled by low PWM duty cycle. It is recommended to input PWM signal with 10% or more duty cycle to prevented LED turn off(Ta=25°C). The table below shows the I_{LED} accuracy at low PWM duty cycle input (low brightness).

 I_{LED} accuracy when low PWM Duty is applied (R1 = 10 Ω)

PWM Duty applied to CE Pin	I	_{LED} Min.	I _{LED} Max.
10% (Frequency = 20kHz to 300kHz)	(0.1mA ⁽¹⁾	5.1mA ⁽¹⁾

⁽¹⁾ Design guaranteed value (Ta = 25 °C)

TECHNICAL NOTES

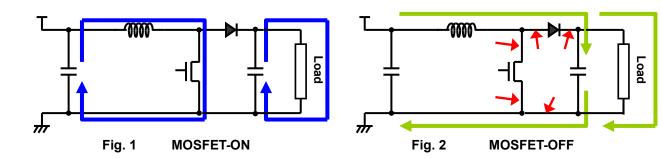
Current Path on PCB

The current paths in an application circuit are shown in Fig. 1 and 2.

A current flows through the paths shown in Fig. 1 at the time of MOSFET-ON, and shown in Fig. 2 at the time of MOSFET-OFF. In the paths pointed with red arrows in Fig. 2, current flows just in MOSFET-ON period or just in MOSFET-OFF period. Parasitic impedance / inductance and the capacitance of these paths influence stability of the system and cause noise outbreak. So please minimize this side effect. In addition, please shorten the wiring of other current paths shown in Fig. 1 and 2 except for the paths of LED load.

Layout Guide for PCB

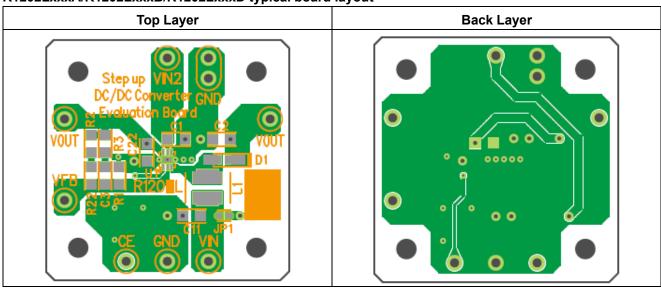
- Please shorten the wiring of the input capacitor (C1) between V_{IN} pin and GND pin of IC. The GND pin should be connected to the strong GND plane.
- The area of Lx land pattern should be smaller.
- Please put output capacitor (C2) close to the Vou⊤ pin.
- · Please make the GND side of output capacitor (C2) close to the GND pin of IC.



PCB Layout

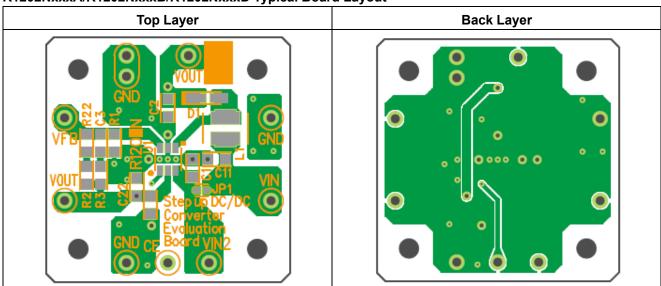
· PKG:DFN1616-6B pin

R1202LxxxA/R1202LxxxB/R1202LxxxD typical board layout



· PKG: TSOT-23-6 pin

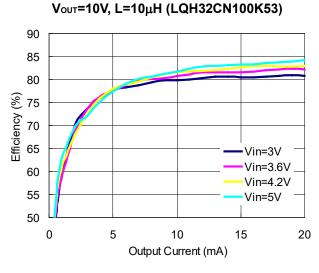
R1202NxxxA/R1202NxxxB/R1202NxxxD Typical Board Layout

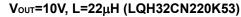


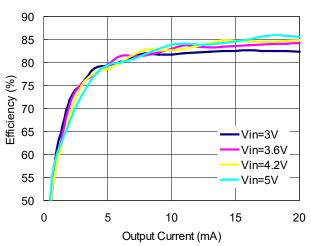
U1-● indicates the position of No.1 pin.

TYPICAL CHARACTERISTICS

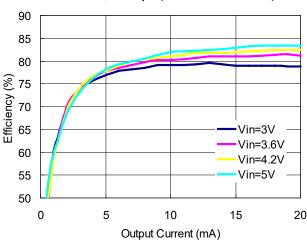
1) Efficiency vs. Output Current (R1202N723A)



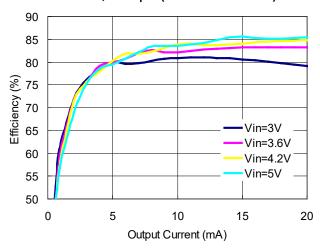




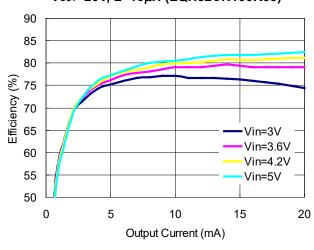




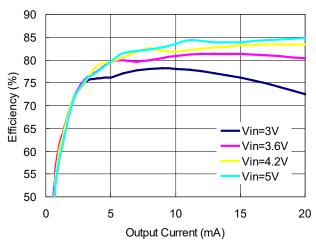
Vουτ=15V, L=22μH (LQH32CN220K53)

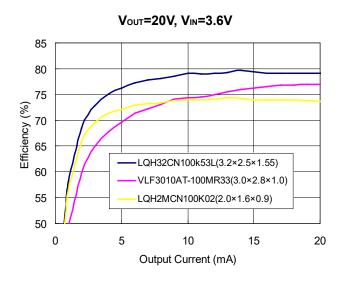


Vouτ=20V, L=10μH (LQH32CN100K53)

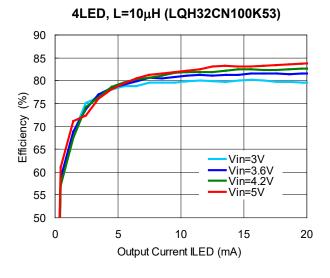


Vouτ=20V, L=22μH (LQH32CN220K53)

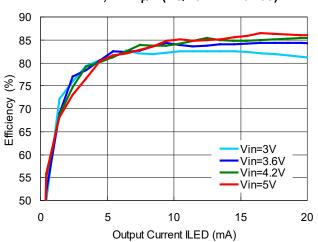




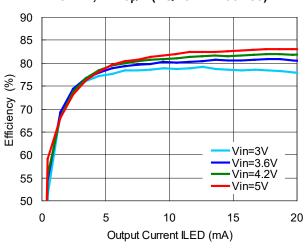
2) Efficiency vs. Output Current (R1202N713D)



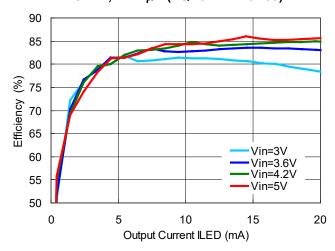
4LED, L=22μH (LQH32CN220K53)



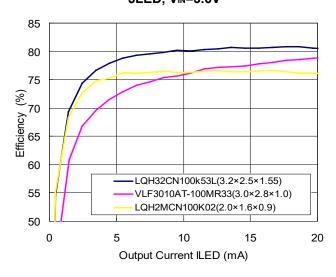




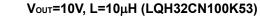
5LED, L=22μH (LQH32CN220K53)

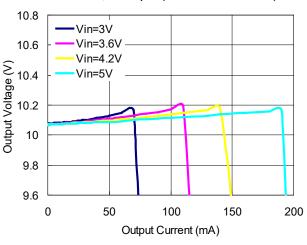


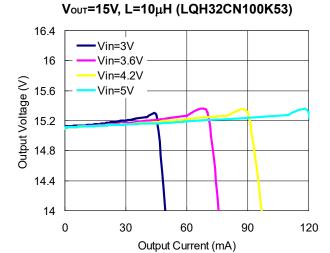
3) Efficiency vs. Output Current (R1202N713D) 5LED, V_{IN}=3.6V



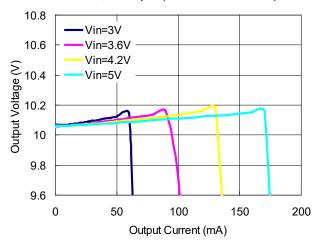
4) Output Voltage vs. Output Current (R1202N723A)



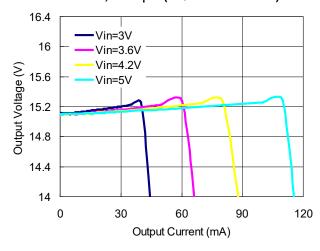




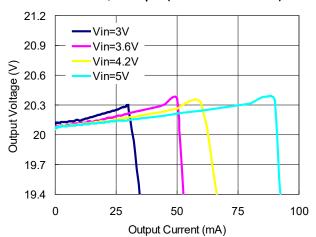
Vouτ=10V, L=22μH (LQH32CN220K53)



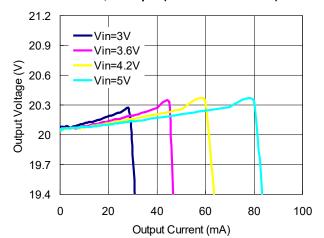
Vouτ=15V, L=22μH (LQH32CN220K53)



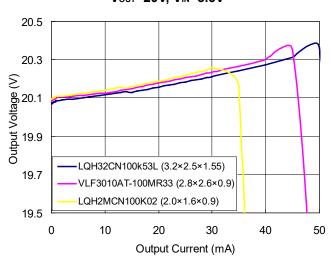
Vouτ=20V, L=10μH (LQH32CN100K53)



V_{OUT}=20V, L=22μH (LQH32CN220K53)



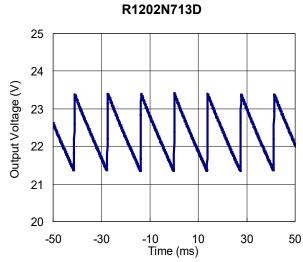
Vout=20V, Vin=3.6V



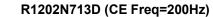
5) Maxduty vs. ILED

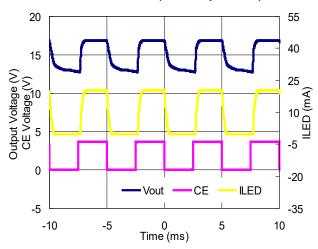


6) OVP Output Waveform

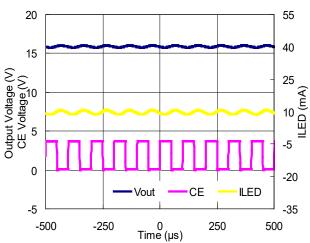


7) Waveform (5LED)

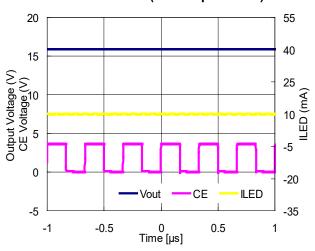




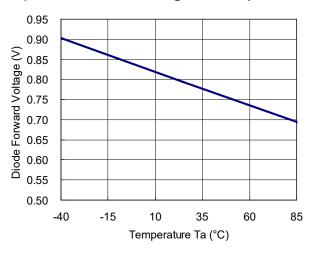
R1202N713D (CE Freq=10KHz)



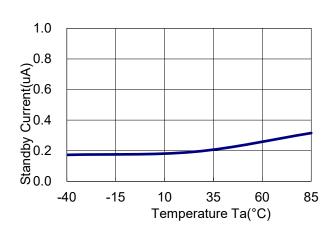
R1202N713D (CE Freq=300KHz)



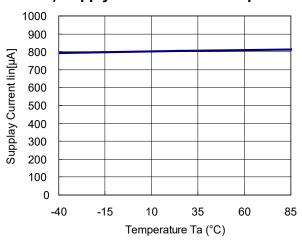
8) Diode Forward Voltage vs. Temperature



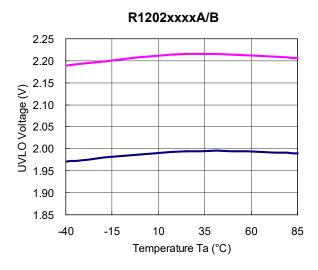
9) Standby Current vs. Temperature

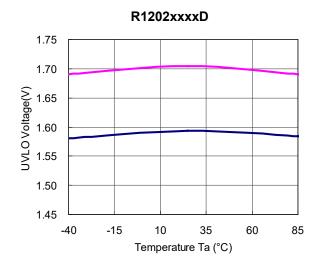


10) Supply Current lin vs. Temperature

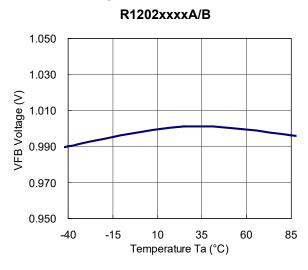


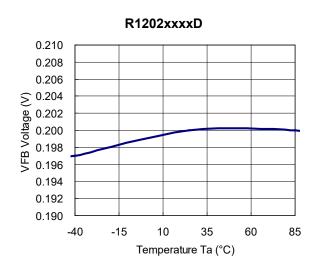
11) UVLO Voltage vs. Temperature



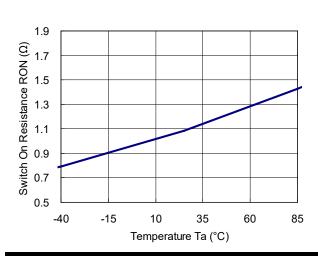


12) VFB Voltage vs. Temperature

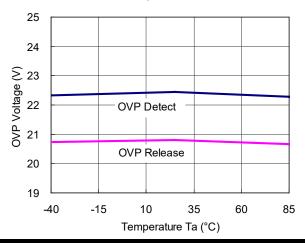




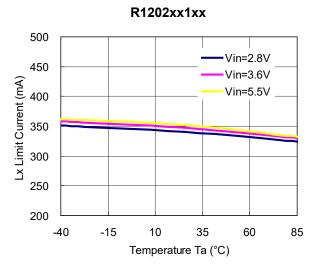
13) Switch ON Resistance RON vs. Temperature

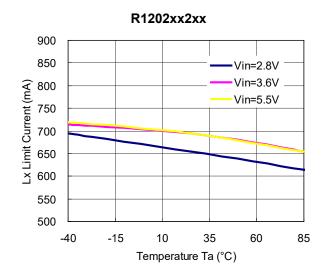


14) OVP Voltage vs. Temperature R1202x7xxx

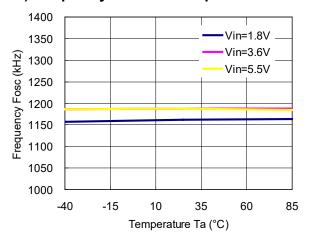


15) Lx Limit Current vs. Temperature

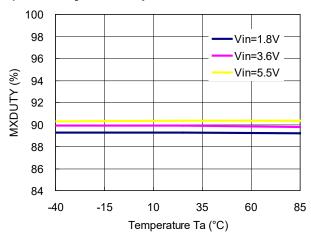




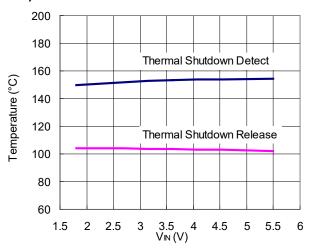
16) Frequency Fosc vs. Temperature



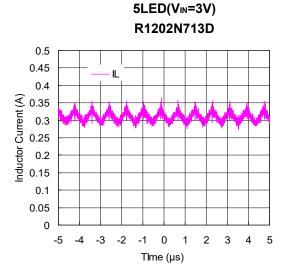
17) MaxDuty vs. Temperature

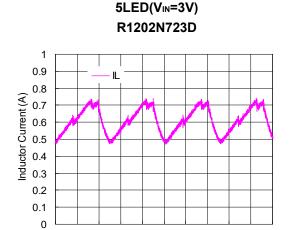


18) Thermal Shutdown Detect / Release Temperature vs. Input Voltage



19) Inductor Current (output-GND short)





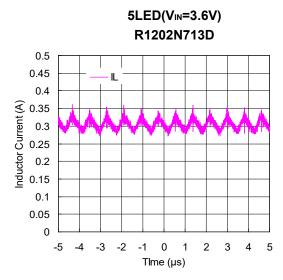
2

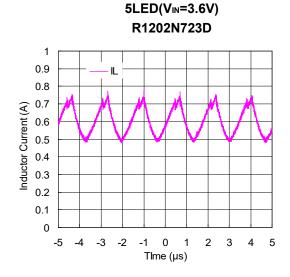
3 4

0 1

Tlme (µs)

-1

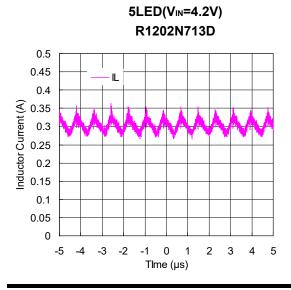


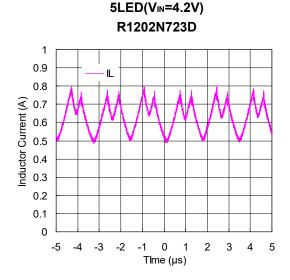


-5

-4

-3 -2

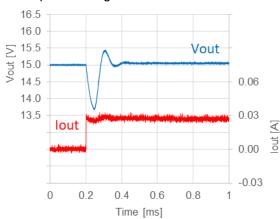


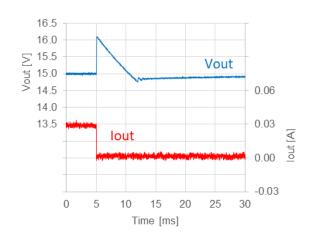


20) Load Transient Response

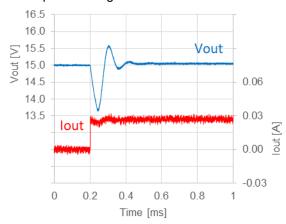
 V_{IN} = 3.6 V, V_{OUT} = 15 V I_{OUT} = 0 mA \Leftrightarrow 30 mA

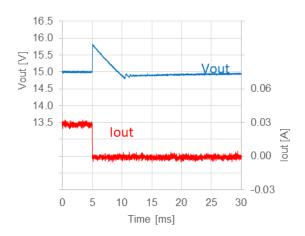
L = 10 µH Setting : Table 3-A



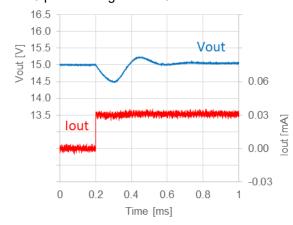


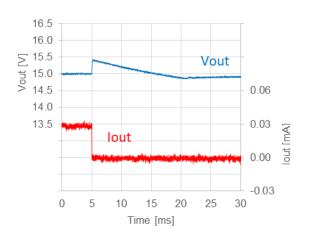
L = 22 µH Setting : Table 3-A



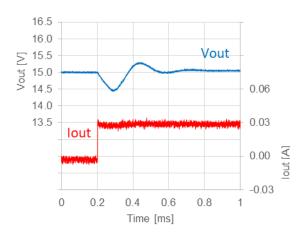


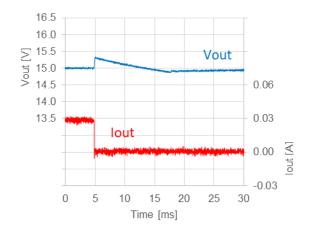
L =10 μH Setting : Table 3-B





 $L = 22 \mu H$ Setting : Table 3-B





The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions		
Environment	Mounting on Board (Wind Velocity = 0 m/s)		
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)		
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm		
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square		
Through-holes	φ 0.2 mm × 15 pcs		

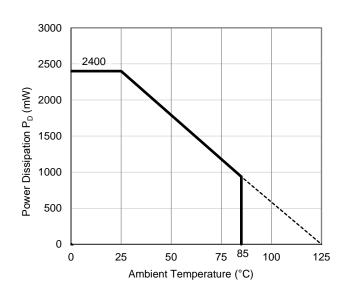
Measurement Result

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

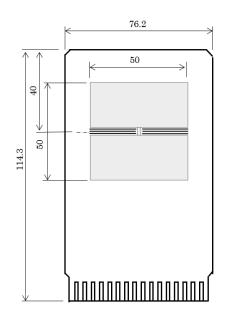
Item	Measurement Result		
Power Dissipation	2400 mW		
Thermal Resistance (θja)	θja = 41°C/W		
Thermal Characterization Parameter (ψjt)	ψjt = 11°C/W		

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter

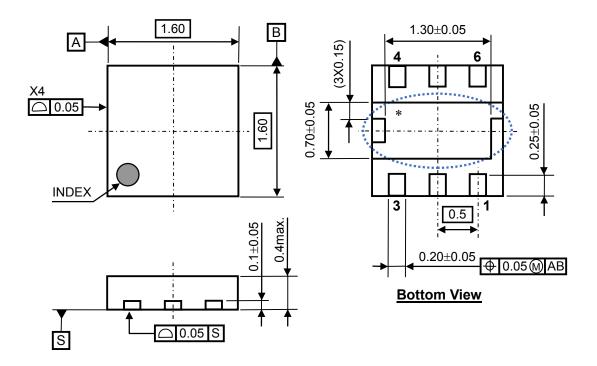


Power Dissipation vs. Ambient Temperature



Measurement Board Pattern

i



DFN1616-6B Package Dimensions (Unit: mm)

i

^{*} The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane pin on the board but it is possible to leave the tab floating.

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

Item	Standard Test Land Pattern	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Double-Sided Board)	
Board Dimensions	40 mm × 40 mm × 1.6 mm	
Copper Ratio	Top Side: Approx. 50%	
Copper Natio	Bottom Side: Approx. 50%	
Through-holes	φ 0.5 mm × 44 pcs	

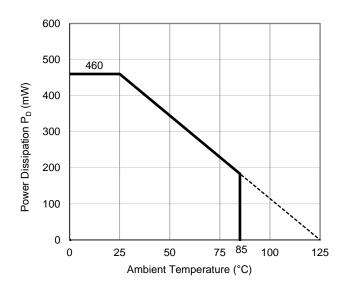
Measurement Result

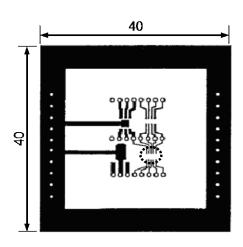
 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

Item	Standard Test Land Pattern		
Power Dissipation	460 mW		
Thermal Resistance (θja)	θja = 217°C/W		
Thermal Characterization Parameter (ψjt) ψjt = 40°C/W			

 θ ja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter

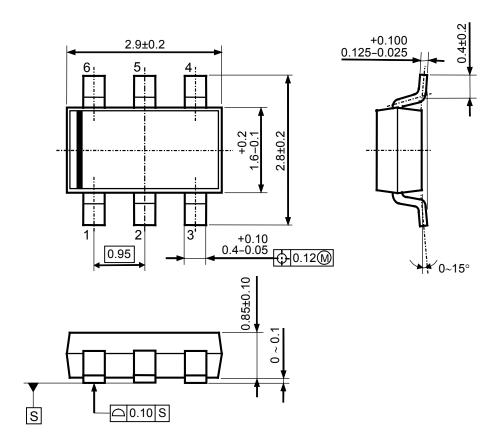




Power Dissipation vs. Ambient Temperature

Measurement Board Pattern

i



TSOT-23-6 Package Dimensions (Unit: mm)



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